GDT
Gas Discharge Tube

SC Series

Description

The Gas Discharge Tube (GDT) is a protective device which is filled with certain proportion of noble gas, or mixed gas or other discharge media in the space between metal electrodes and metalized ceramics, and then sealed at high temperature to form a single-gap or multi-gap switch type protective device. When the protected circuit or equipment suffers to surge, GDT will change from high impedance state to low impedance state and release the surge energy to reduce the residual voltage of the circuit, and then protect the equipment or humanbody from the hazard of transient overvoltage.

Features

- Fast Response
- Stable Performance Over Surface Life
- High Current Rating
- Low Capacitance
- High Insulation Resistance
- RoHS & REACH Compliant

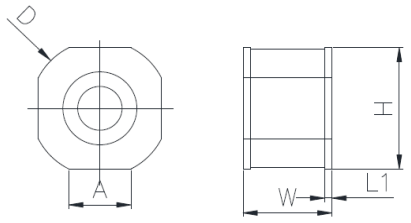
Agency Approvals

Agency	Standards	File No.
	UL497B	On-going
	TUV	On-going

Applications

- WLAN XDSL
- CATV
- MDF
- Ethernet
- BTS (Base Station)
- Power Supply
- Antenna and RF
- Consumer Electronics
- N-PE Protection in AC Power

Dimensions (mm)



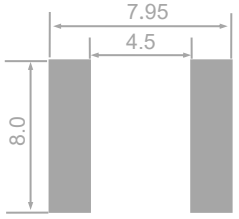
D	H	W
Φ 9.3 ± 0.2	8.3 ± 0.2	6.0 ± 0.2
L1	**A**	
0.5	4.2	

Part Number System

SC 601 H - SMD

- SMD: Lead Type (L: Lead wire, Brank: without Lead Wire, SMD)
- H: Impulse Discharge Current (I_n = T: 3 kA, A: 5 kA, M: 10 kA, H: 20 kA)
- 601: D.C. Spark-over Voltage (100 V/s) (601: 60×10^1)
- SC: Series: SC (6 × 8.3 × 8.3 mm)

Recommendation Pad Size (mm)



Glossary

Item	Description
V_s	**D.C.Spark-over Voltage** The voltage at which the GDT sparks over with slowly increasing d.c. voltage. — (IEC 61643-311)
V	**Impulse Spark-over Voltage** The highest Voltage which appears across the terminals of a GDT in the period between the application of an impulse of given wave-shape and the time when current begins to flow. — (ITU-T K.12)
V_a	**Arc Voltage** Voltage drop across the GDT during arc current flow. — (IEC 61643-311)
V_{gl}	**Glow Voltage** The peak value of the voltage drop across the GDT when a glow-current is flowing, It is sometimes called the glow mode voltage. — (ITU-T K.12)
8/20 μs	**8/20 Current Impulse** Current impulse with a nominal virtual front time of 8 μs and a nominal time to half-value of 20 μs. — (IEC 61643-11)
1.2/50 μs	**1.2/50 Voltage Impulse** Voltage impulse with a nominal virtual front time of 1.2 μs and a nominal time to half-value of 50 μs. — (IEC 61643-11)
I	**Alternating Discharge Current** The r.m.s. value of an approximately sinusoidal alternating current passing through the GDT. — (ITU-T K.12)
I_n	**Nominal Discharge Current** Crest value of the current through the GDT having a current waveshape of 8/20 μs. — (IEC 61643-11)
I_{max}	**Maximum Discharge Current** Crest value of a current through the GDT having an 8/20 μs waveshape and magnitude according to the manufacturers specification. I_{max} is equal to or greater than I_n. — (IEC 61643-11)

GDT

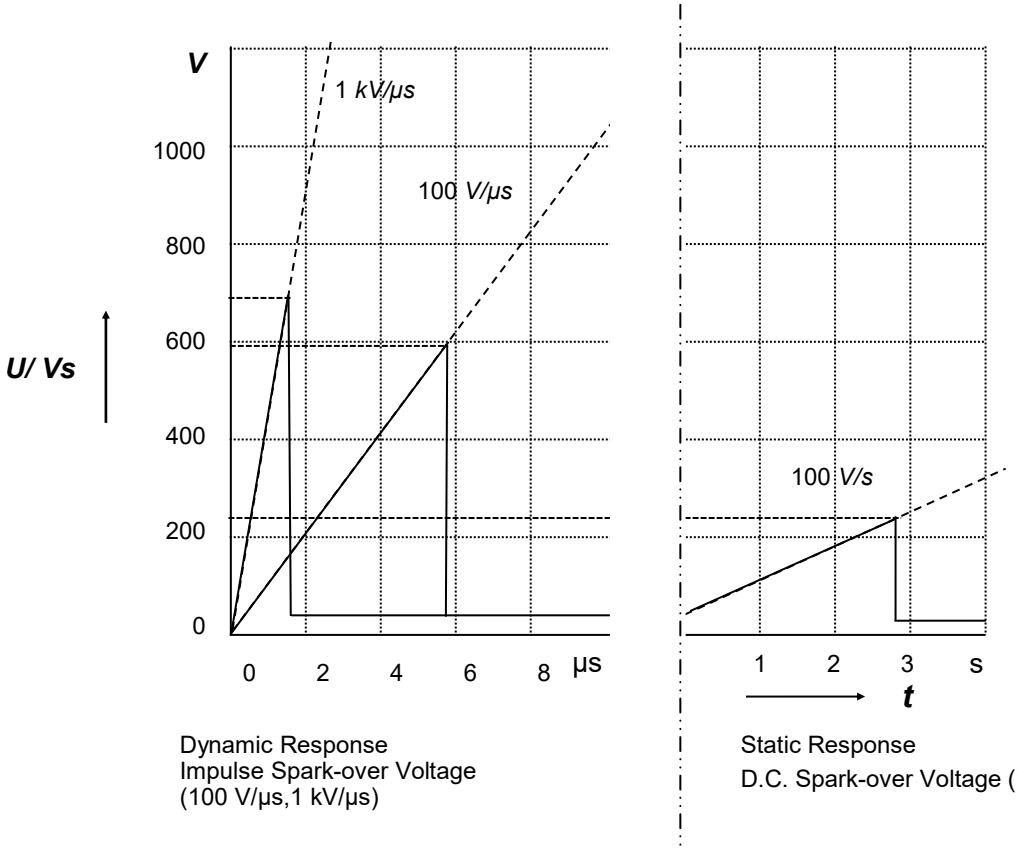
Specifications

Model	D.C. Spark-over Voltage @100 V/s	Tolerance of V_s	Impulse Spark-over Voltage @1 kV/μs	Arc Voltage @1 A	Impulse Discharge Current @8/20 μs	Alternating Discharge Current @50Hz 1 s	Insulation Resistance		Capacitance 0.5 VDC @ 1MHz	Agency Approvals	
	V_s	V_s	V	V_a	I_n	I	V_{DC}	IR	C		
	V	V	V	V	kA	A (r.m.s.)	V	GΩ	(pF)	UL497B	TUV
SC071H - SMD	70	52 ~ 88	≤ 600	≈ 8	20	20	25	≥ 1	≤ 1.5	●	○
SC075H - SMD	75	57 ~ 93	≤ 650	≈ 8	20	20	25	≥ 1	≤ 1.5	●	○
SC091H - SMD	90	72 ~ 108	≤ 600	≈8	20	20	50	≥ 1	≤ 1.5	●	○
SC151H - SMD	150	120 ~ 180	≤ 600	≈8	20	20	50	≥ 1	≤ 1.5	●	○
SC201H - SMD	200	160 ~ 240	≤ 700	≈10	20	20	100	≥ 1	≤ 1.5	○	○
SC231H - SMD	230	184 ~ 280	≤ 700	≈10	20	20	100	≥ 1	≤ 1.5	●	○
SC251H - SMD	250	200 ~ 300	≤ 700	≈10	20	20	100	≥ 1	≤ 1.5	●	○
SC301H - SMD	300	240 ~ 360	≤ 800	≈10	20	20	100	≥ 1	≤ 1.5	○	○
SC351H - SMD	350	280 ~ 420	≤ 1000	≈10	20	20	100	≥ 1	≤ 1.5	●	○
SC421H - SMD	420	366 ~ 504	≤ 1000	≈12	20	20	100	≥ 1	≤ 1.5	●	○
SC471H - SMD	470	376 ~ 564	≤ 1200	≈12	20	20	100	≥ 1	≤ 1.5	●	○
SC601H - SMD	600	480 ~ 720	≤ 1400	≈15	20	20	100	≥ 1	≤ 1.5	●	○
SC801H - SMD	800	640 ~ 960	≤ 1600	≈ 15	20	20	100	≥ 1	≤ 1.5	●	○

Note:
1. The above parameters based on ITU - T K12 & IEC61643.311 standards.
2. "●" means GDT has gained the certification.
   "○" means GDT is planed to apply for certification.

GDT

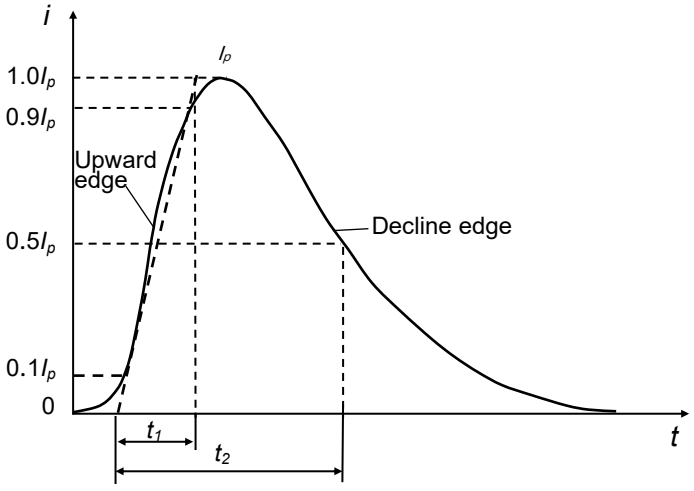
Reference Curve for Spark-over Voltage (Refer to 230 VDC)



Dynamic Response
Impulse Spark-over Voltage
(100 V/μs,1 kV/μs)

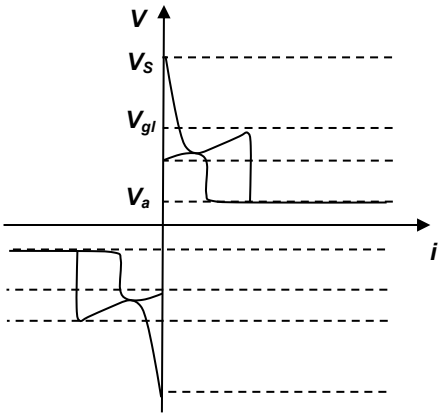
Static Response
D.C. Spark-over Voltage (100 V/s)

Reference Curve for Impulse Discharge Current

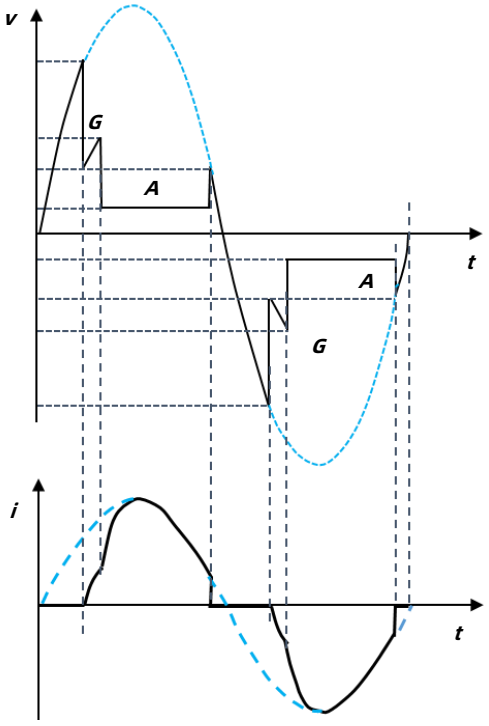


I_p: Peak current
t_1: Rise time in μs
t_2: Delay time to half value in μs

Electrical Characteristics



Relationship between Current and Voltage

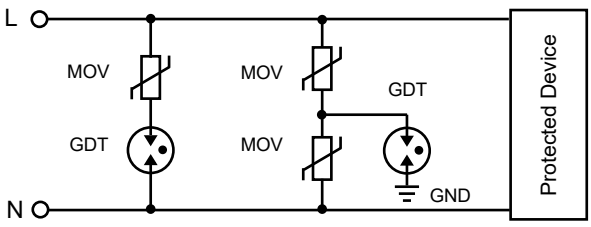


Time Variation Patterns of Voltage and Current

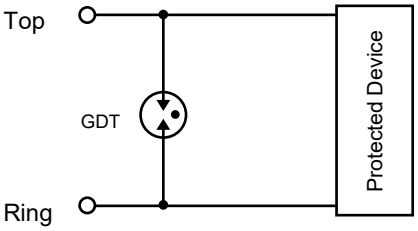
V_s : Spark-over Voltage
Vgl: Glow Voltage
Va : Arc Voltage
G : Glow Mode
A : Arc Mode

Application Example

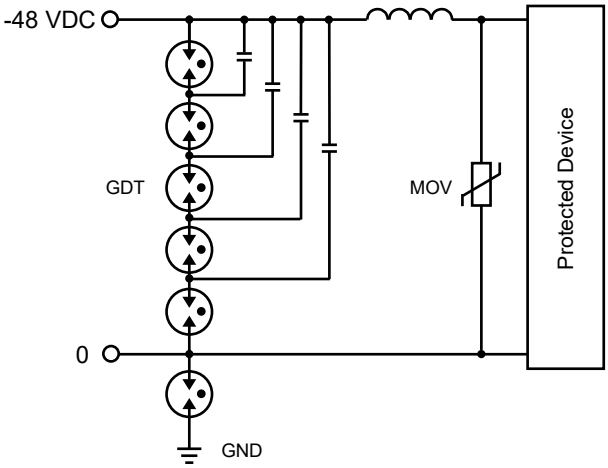
AC Power Protection



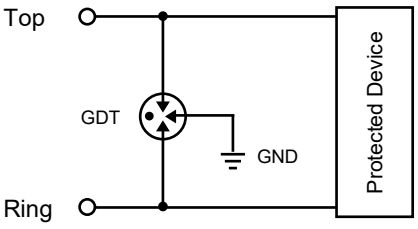
2-Electrod GDT Signal Circuit Protection



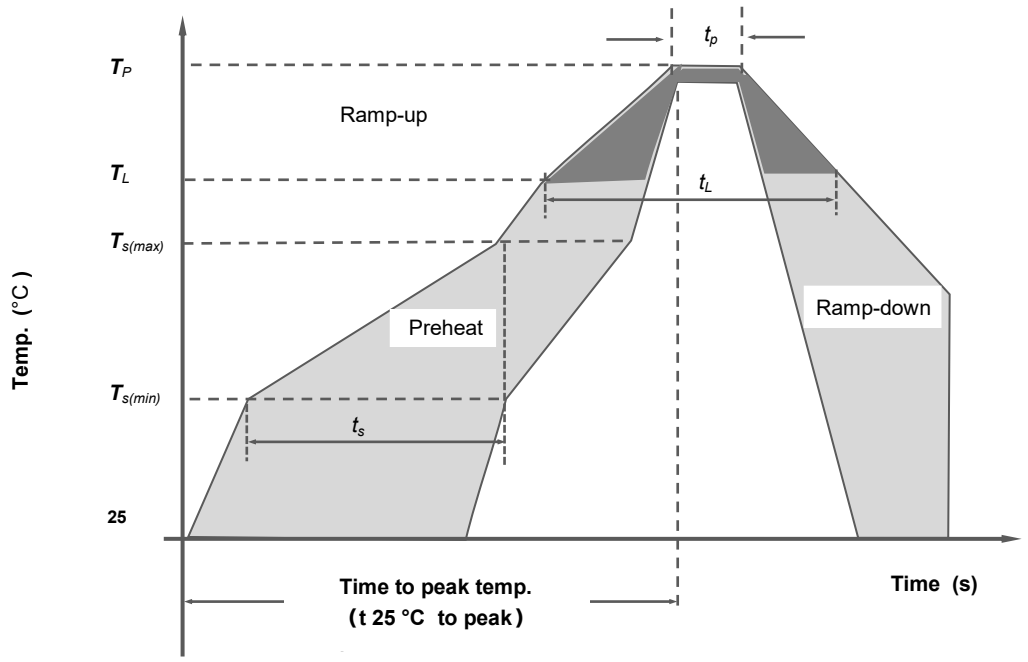
DC Power Protection



3-Electrod GDT Signal Circuit Protection



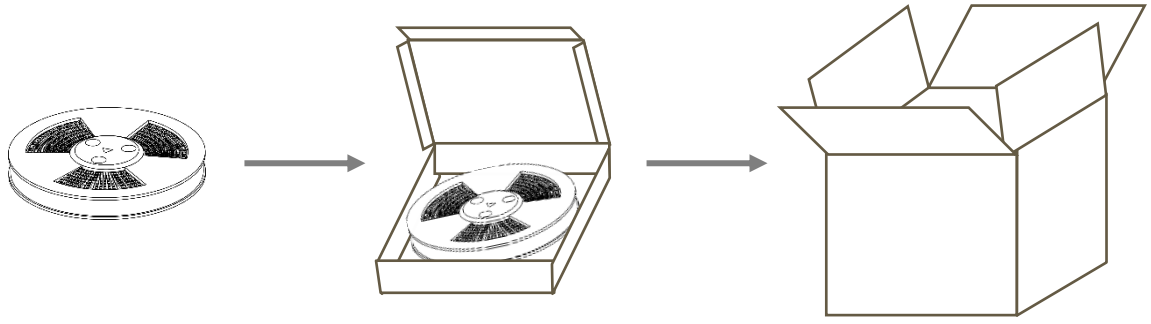
Reflow Soldering Parameters (Reference)



Reflow Condition		Pb-Free Assembly
Preheat	Temp. Min $T_{s(min)}$	150 °C
	Temp. Max $T_{s(max)}$	200 °C
	Time (Min to Max) t_s	(60 to 180) s
Average ramp up rate (Liquidus Temp. (T_L) to peak)		3 °C / second max
$T_{s\ (max)}$ to T_L Ramp-up Rate		5 °C / second max
Reflow	Temp. (T_L) (Liquidus)	217 °C
	Temp. (t_L)	(60 to 150) s
Peak Temp. (T_P)		(255 to 260) °C
Time within 5 °C of actual peak Temp. (t_P)		(10 to 30) s
Ramp-down Rate		6 °C / second max
Time 25 °C to peak Temp. (T_P)		8 minutes max
Do not exceed		260 °C

Packaging Information

Item	Reel	Inner Box	Carton
Dimensions (mm)	Φ 330 × 16.8	340 × 340 × 40	360 × 360 × 360
Quantity (PCS)	600	1200	8400
Notes: Packaging dimensions and quantity are for reference only.			



Reel Inner Box Carton

Please refer to the specifications for the packaging details.

GDT

ATTENTION

Usage

1. Do not operate GDT in power supply networks, whose maximum operation voltage exceeds the minimum spark-overvoltage of the GDT.
2. The GDT may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
3. If the contacts of GDT are defective, current load can cause sparks and loud noises.
4. When air pressure is from 55 kPa to 106 kPa. The relative altitude shall be +5000 m to –500 m.

Replacement

The GDT is a non-repairable product. For safety sake, please use equivalent GDT for replacement.

Storage

The packaged GDT should be placed in a dry, ventilation and non-corrosive environment.

Installation Position

Do not install the GDT in a touchable position.

Mechanical Stress

Do not take violent action such as knocking when assembling, to avoid product failure.